



Aluminium Electrolytic Capacitor

Material Data Sheet

Product Class:	Large size capacitors with copper terminals	
Date	2011.10.20	
IMDS ID if available		
Version:	06	

Product Part (IMDS: semi component)	Material Class (IMDS: Material)	Material (Classification) VDA 231	Substance	TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)
Active Part	Light Metals	1B	Aluminium	100	7429-90-5	43	
	Acids, Bases, Salts	6F	Gamma-butyrolactone	57	96-48-0	23	
	Acids, Bases, Salts	6F	N-methyl-2-pyrrolidone	23	872-50-4		
	Acids, Bases, Salts	6F	Others*)	20	-		
	Thermoplastics	2A	Polypropylene	100	9003-07-0	0,2	
	Paper, Cardboard	5C	Cellulose	100	9004-34-6	11,8	
Encapsulation	Light Metals	1B	Aluminium	100	7429-90-5	11,5	
	Paper, Cardboard	5C	Cellulose	56	9004-34-6	3,9	
	Duromer	2D	Phenolic plastic	44	-		
	Elastomer	2B	EPDM rubber	100	25038-36-2	1,8	
	Thermoplastics	2A	PTFE	100	9003-07-0	0,3	
	Thermoplastics	2A	Polyethylene terephthalate or without insulation	100	9002-86-2	3	
Termination	Heavy Metals	1C	Copper (E-Cu58 F21-V5)	100	7440-50-8	1,5	
	Heavy Metals	1C	Tin	100	7440-31-5	<0,1	
Sum in total:						100	

sizes D x L [mm]	weight range [g]	sizes [g]	weight range [mm]	sizes [g]	weight range [mm]	part numbers B41605, B41607 **)
22 x 30	14	25 x 40	28	30 x 30	28	
22 x 40	21	25 x 45	31	30 x 50	50	
22 x 45	24	25 x 50	35	35 x 50	68	
		25 x 55	39			

Not part of a Product Class

Contact	Dr. Ildikó Száraz	Important remarks: 1) The declaration limit is 0.1% as defined by IEC PAS 61906. Traces are product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise regulated 2) This Material Data Sheet contains typical values of the respective products set forth herein. We expressly point out that all values and statements contained herein are based on our best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. EPCOS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.
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*) others: (not declarable or prohibited substances acc. GADSL)		
**) typical mass percentage of substance		
***) exception: B41605S5828M 1S 1; where NMP free electrolyte is used (GBL 85%; others*) 15%)		

The products set forth herein are "RoHS-compatible". RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

RoHS - Exemptions for the Product Class / Product according to Annex III: (valid not valid)

no exemptions:

- Exemption 6 (a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0,35 % lead by weight;
- Exemption 6 (b): Lead as an alloying element in aluminium containing up to 0,4 % lead by weight;
- Exemption 6 (c): Copper alloy containing up to 4 % lead by weight;
- Exemption 7 (a): Lead in high melting temperature type solder (i.e. lead-based alloys containing 85 % by weight or more lead);
- Exemption 7 (c)-I: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound;
- Exemption 7 (c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher;
- Exemption 7 (c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC;
- Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;
- Other Exemption than above

